ASSOCIATION CONNECT	Material Compo © Copyright 2005. IP international and Pan-	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute					Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information			
Supplier Infor	rmation														
Company name* Company unique				que ID Uni			Unique ID Authority					Response Date*			
onsemi											2023-06-08				
Contact Name		Title - Contact]	Phone - Contact*					Email - Contact*				
Product-Env-Ste	wards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Repre	esentative*	Title - Representative]	Phone - Representative*				Email - Representative*					
Product-Env-Ste	wards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Reque	ster Item Number	Mfr Item Number		Mfr Item Name			Effective Dat	Date Version Manufacturing Site		ring Site	V	Veight*	UOM	Unit Type	
		LV8548MC-AH 2-ch Brush Moto		: Driver		2023-06-08					7	2.0	mg	Each	
Ianufacturin	g Proccess Informat	ion													
Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020 MS		SL Rating	Peak Process Body Tempera		ure Max Time at Peak Temper		Temperatu	are Num	nber of Reflow Cyc	cles		
Matte Tin (Sn) - annealed			CU Alloy 3			260		C	30		secono	is 3			
omments															
TTENTION: M	SL 3 Rated item requires	Bake and D	ry Pack (afte	r electrical test)											
or more informa	ation regarding material o	composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a						
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of				
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the				

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.61	mg	Supplier	Silicon (Si)	7440-21-3		2.6003	mg
			Supplier	Polyimide	Proprietary Data		0.0097	mg
Die Attach	0.28	mg		Epoxy resin	proprietary data		0.028	mg
			Supplier	Ethylene dimethacrylate	97-90-5		0.014	mg
			Supplier	Silver (Ag)	7440-22-4		0.224	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.014	mg
Lead Frame	37.62	mg	Supplier	Silver (Ag)	7440-22-4		0.79	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0752	mg
			Supplier	Iron (Fe)	7439-89-6		0.9367	mg
			Supplier	Copper (Cu)	7440-50-8		35.818	mg
Mold Compound-Black	29.51	mg		Epoxy resin	proprietary data		1.4755	mg
			Supplier	Phenol Resin	Proprietary Data		1.1804	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		2.951	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2951	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		23.608	mg
Plating	1.89	mg	Supplier	Tin (Sn)	7440-31-5		1.89	mg
Wire Bond - Cu	0.09	mg	Supplier	Copper (Cu)	7440-50-8		0.09	mg